

## RoHS Lab Analysis Report and Certification



**Product Description:** TVS AXIAL HI-POWER - SLD36 BI LDDIODE  
**Product Number:** SLD36-018

This document hereby certifies that the aforementioned product and all its associated materials, are in compliance with RoHS Directive (EU) 2015/863 of the European Parliament and of the Council on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

Furthermore, it is hereby reported that the aforementioned product is composed of the following

Table 1. Product material composition and applicable RoHS exemption(s)

ICP ID	Raw Material Part Number	Raw Material Description	Applicable RoHS Exemption(s)
ICP-0027	IC Wafer	Silicon Chip	
ICP-0029	Propriety	Wafer Passivation	7c-I
ICP-1785	-	Lead Wire	
ICP-0031	-	Solder Wafer	7a
ICP-0033	-	Copper Spacer	
ICP-0028	-	Epoxy Molding compound	
ICP-0034	Pure Matte Tin	Tin Plating	
ICP-0035	-	Ink	

Remarks: 7a - Lead in high melting temperature type solders (lead-based alloys containing 85 % by weight or more lead)  
7c-I - Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors (piezoelectronic devices) or in a glass or ceramic matrix compound

**To view the third party RoHS validation report of these materials, see download procedure |**

1. Go to "ICP Test Report" section in LFBC. (ICP Test report is located below Information Databas
2. Find and download the ICP report using ICP ID in the search box.

**Issued by:**



Diana Jane De Guzman - Gabinete  
Global EHS Analyst



**Noted by:** Jennilyn D. Santos  
Global EHS Supervisor